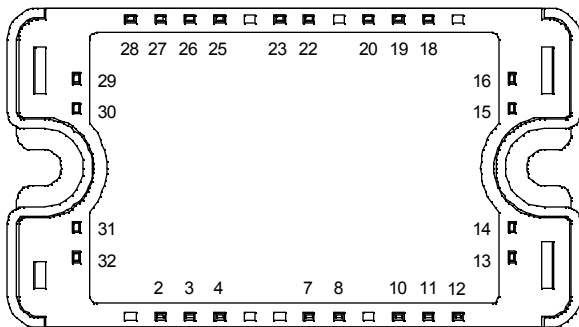
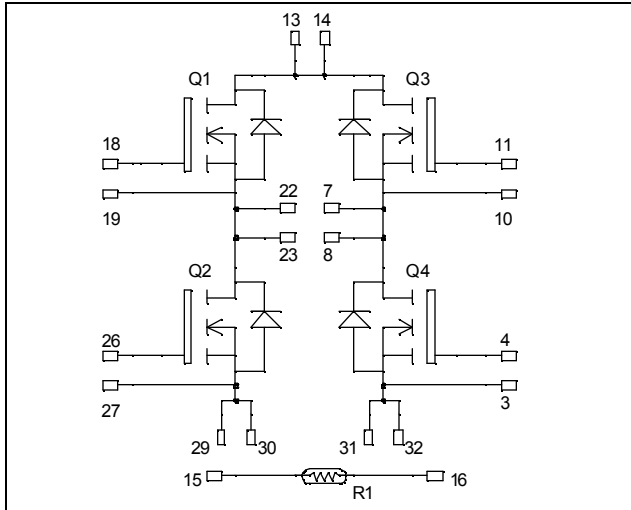


## Full - Bridge MOSFET Power Module

$$V_{DSS} = 100V$$

$$R_{DSon} = 19m\Omega \text{ typ @ } T_j = 25^\circ C$$

$$I_D = 70A \text{ @ } T_c = 25^\circ C$$



All multiple inputs and outputs must be shorted together  
 Example: 13/14 ; 29/30 ; 22/23 ...

### Application

- Welding converters
- Switched Mode Power Supplies
- Uninterruptible Power Supplies
- Motor control

### Features

- Power MOS V<sup>®</sup> FREDFETs
  - Low  $R_{DSon}$
  - Low input and Miller capacitance
  - Low gate charge
  - Fast intrinsic diode
  - Avalanche energy rated
  - Very rugged
- Kelvin source for easy drive
- Very low stray inductance
  - Symmetrical design
- Internal thermistor for temperature monitoring
- High level of integration

### Benefits

- Outstanding performance at high frequency operation
- Direct mounting to heatsink (isolated package)
- Low junction to case thermal resistance
- Solderable terminals both for power and signal for easy PCB mounting
- Low profile
- Each leg can be easily paralleled to achieve a phase leg of twice the current capability
- RoHS Compliant

### Absolute maximum ratings

| Symbol     | Parameter                                         | Max ratings        | Unit      |
|------------|---------------------------------------------------|--------------------|-----------|
| $V_{DSS}$  | Drain - Source Breakdown Voltage                  | 100                | V         |
| $I_D$      | Continuous Drain Current                          | $T_c = 25^\circ C$ | A         |
|            |                                                   | $T_c = 80^\circ C$ |           |
| $I_{DM}$   | Pulsed Drain current                              | 300                |           |
| $V_{GS}$   | Gate - Source Voltage                             | $\pm 30$           | V         |
| $R_{DSon}$ | Drain - Source ON Resistance                      | 21                 | $m\Omega$ |
| $P_D$      | Maximum Power Dissipation                         | $T_c = 25^\circ C$ | 208       |
| $I_{AR}$   | Avalanche current (repetitive and non repetitive) | 75                 | A         |
| $E_{AR}$   | Repetitive Avalanche Energy                       | 30                 | mJ        |
| $E_{AS}$   | Single Pulse Avalanche Energy                     | 1500               |           |



CAUTION: These Devices are sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed. See application note APT0502 on [www.microsemi.com](http://www.microsemi.com)

**All ratings @  $T_j = 25^\circ\text{C}$  unless otherwise specified**

**Electrical Characteristics**

| Symbol       | Characteristic                  | Test Conditions                                                     | Min | Typ | Max       | Unit             |
|--------------|---------------------------------|---------------------------------------------------------------------|-----|-----|-----------|------------------|
| $I_{DSS}$    | Zero Gate Voltage Drain Current | $V_{GS} = 0\text{V}, V_{DS} = 100\text{V}$ $T_j = 25^\circ\text{C}$ |     |     | 250       | $\mu\text{A}$    |
|              |                                 | $V_{GS} = 0\text{V}, V_{DS} = 80\text{V}$ $T_j = 125^\circ\text{C}$ |     |     | 1000      |                  |
| $R_{DS(on)}$ | Drain – Source on Resistance    | $V_{GS} = 10\text{V}, I_D = 35\text{A}$                             |     | 19  | 21        | $\text{m}\Omega$ |
| $V_{GS(th)}$ | Gate Threshold Voltage          | $V_{GS} = V_{DS}, I_D = 1\text{mA}$                                 | 2   |     | 4         | V                |
| $I_{GSS}$    | Gate – Source Leakage Current   | $V_{GS} = \pm 30\text{V}, V_{DS} = 0\text{V}$                       |     |     | $\pm 100$ | nA               |

**Dynamic Characteristics**

| Symbol       | Characteristic               | Test Conditions                                                                                                                                         | Min | Typ  | Max | Unit          |
|--------------|------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------|-----|------|-----|---------------|
| $C_{iss}$    | Input Capacitance            | $V_{GS} = 0\text{V}$<br>$V_{DS} = 25\text{V}$<br>$f = 1\text{MHz}$                                                                                      |     | 5100 |     | pF            |
| $C_{oss}$    | Output Capacitance           |                                                                                                                                                         |     | 1900 |     |               |
| $C_{rss}$    | Reverse Transfer Capacitance |                                                                                                                                                         |     | 800  |     |               |
| $Q_g$        | Total gate Charge            | $V_{GS} = 10\text{V}$<br>$V_{Bus} = 100\text{V}$<br>$I_D = 70\text{A}$                                                                                  |     | 200  |     | nC            |
| $Q_{gs}$     | Gate – Source Charge         |                                                                                                                                                         |     | 40   |     |               |
| $Q_{gd}$     | Gate – Drain Charge          |                                                                                                                                                         |     | 92   |     |               |
| $T_{d(on)}$  | Turn-on Delay Time           | <b>Inductive switching @ <math>125^\circ\text{C}</math></b><br>$V_{GS} = 15\text{V}$<br>$V_{Bus} = 66\text{V}$<br>$I_D = 70\text{A}$<br>$R_G = 5\Omega$ |     | 35   |     | ns            |
| $T_r$        | Rise Time                    |                                                                                                                                                         |     | 70   |     |               |
| $T_{d(off)}$ | Turn-off Delay Time          |                                                                                                                                                         |     | 95   |     |               |
| $T_f$        | Fall Time                    |                                                                                                                                                         |     | 125  |     |               |
| $E_{on}$     | Turn-on Switching Energy     | <b>Inductive switching @ <math>25^\circ\text{C}</math></b><br>$V_{GS} = 15\text{V}, V_{Bus} = 66\text{V}$<br>$I_D = 70\text{A}, R_G = 5\Omega$          |     | 276  |     | $\mu\text{J}$ |
| $E_{off}$    | Turn-off Switching Energy    |                                                                                                                                                         |     | 302  |     |               |
| $E_{on}$     | Turn-on Switching Energy     | <b>Inductive switching @ <math>125^\circ\text{C}</math></b><br>$V_{GS} = 15\text{V}, V_{Bus} = 66\text{V}$<br>$I_D = 70\text{A}, R_G = 5\Omega$         |     | 304  |     | $\mu\text{J}$ |
| $E_{off}$    | Turn-off Switching Energy    |                                                                                                                                                         |     | 320  |     |               |

**Source - Drain diode ratings and characteristics**

| Symbol   | Characteristic                         | Test Conditions                                                                    | Min                       | Typ | Max | Unit          |
|----------|----------------------------------------|------------------------------------------------------------------------------------|---------------------------|-----|-----|---------------|
| $I_S$    | Continuous Source current (Body diode) | $T_c = 25^\circ\text{C}$                                                           |                           |     | 70  | A             |
|          |                                        | $T_c = 80^\circ\text{C}$                                                           |                           |     | 50  |               |
| $V_{SD}$ | Diode Forward Voltage                  | $V_{GS} = 0\text{V}, I_S = -70\text{A}$                                            |                           |     | 1.3 | V             |
| $dv/dt$  | Peak Diode Recovery ❶                  |                                                                                    |                           |     | 5   | V/ns          |
| $t_{rr}$ | Reverse Recovery Time                  | $I_S = -70\text{A}$<br>$V_{Bus} = 66\text{V}$<br>$di/dt = 100\text{A}/\mu\text{s}$ | $T_j = 25^\circ\text{C}$  |     | 200 | ns            |
|          |                                        |                                                                                    | $T_j = 125^\circ\text{C}$ |     | 350 |               |
| $Q_{rr}$ | Reverse Recovery Charge                | $T_j = 25^\circ\text{C}$                                                           |                           | 0.5 |     | $\mu\text{C}$ |
|          |                                        |                                                                                    | $T_j = 125^\circ\text{C}$ | 1   |     |               |

❶  $dv/dt$  numbers reflect the limitations of the circuit rather than the device itself.

$$I_S \leq -70\text{A} \quad di/dt \leq 700\text{A}/\mu\text{s} \quad V_R \leq V_{DSS} \quad T_j \leq 150^\circ\text{C}$$

## Thermal and package characteristics

| Symbol            | Characteristic                                                            |             |    | Min  | Typ | Max | Unit |
|-------------------|---------------------------------------------------------------------------|-------------|----|------|-----|-----|------|
| R <sub>thJC</sub> | Junction to Case Thermal Resistance                                       |             |    |      |     | 0.6 | °C/W |
| V <sub>ISOL</sub> | RMS Isolation Voltage, any terminal to case t =1 min, I isol<1mA, 50/60Hz |             |    | 2500 |     |     | V    |
| T <sub>J</sub>    | Operating junction temperature range                                      |             |    | -40  |     | 150 | °C   |
| T <sub>STG</sub>  | Storage Temperature Range                                                 |             |    | -40  |     | 125 |      |
| T <sub>C</sub>    | Operating Case Temperature                                                |             |    | -40  |     | 100 |      |
| Torque            | Mounting torque                                                           | To heatsink | M4 | 2.5  |     | 4.7 | N.m  |
| Wt                | Package Weight                                                            |             |    |      |     | 110 | g    |

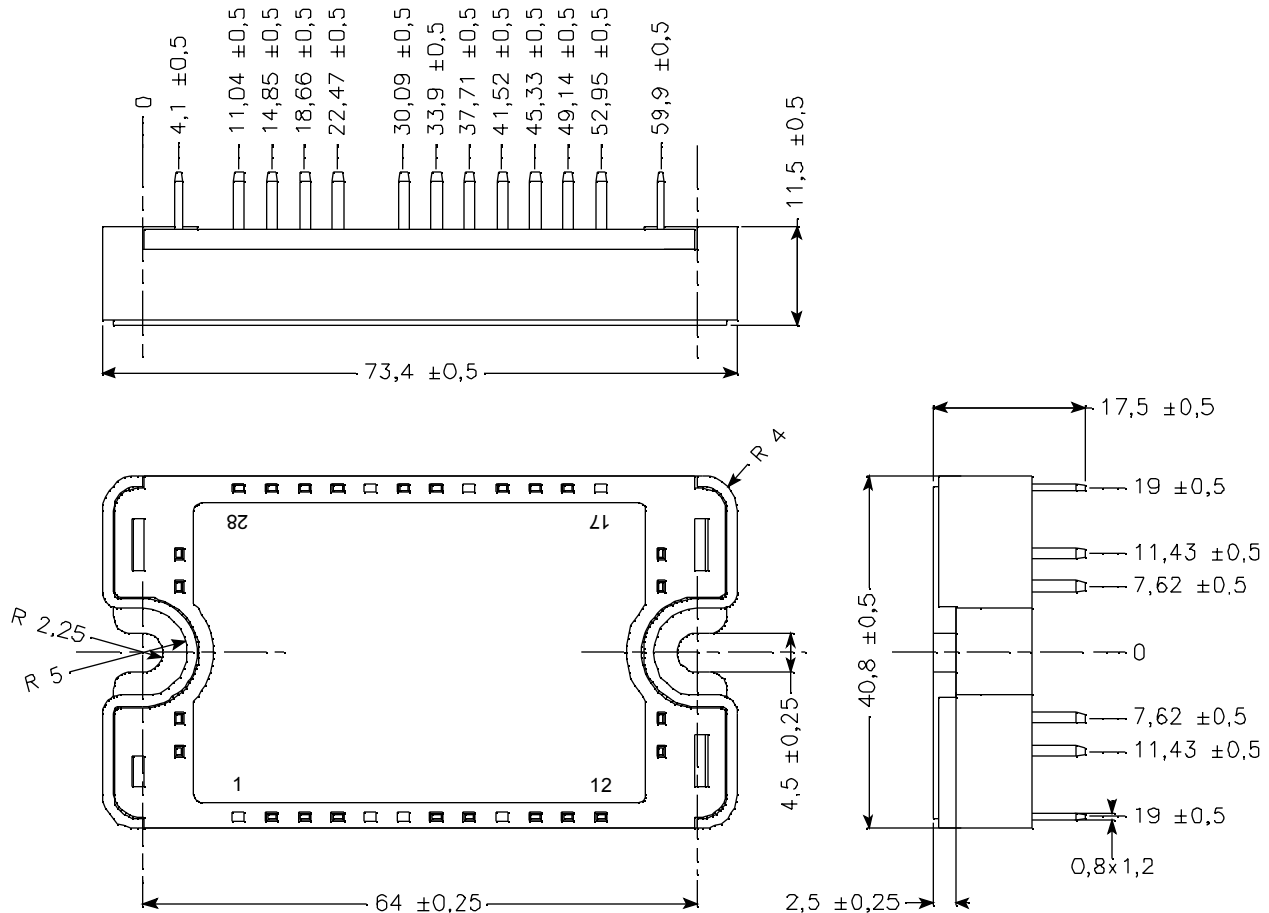
## Temperature sensor NTC (see application note APT0406 on www.microsemi.com for more information).

| Symbol             | Characteristic             | Min | Typ  | Max | Unit |
|--------------------|----------------------------|-----|------|-----|------|
| R <sub>25</sub>    | Resistance @ 25°C          |     | 50   |     | kΩ   |
| B <sub>25/85</sub> | T <sub>25</sub> = 298.15 K |     | 3952 |     | K    |

$$R_T = \frac{R_{25}}{\exp \left[ B_{25/85} \left( \frac{1}{T_{25}} - \frac{1}{T} \right) \right]}$$

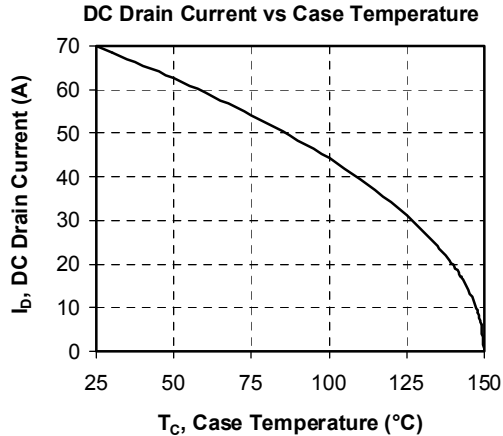
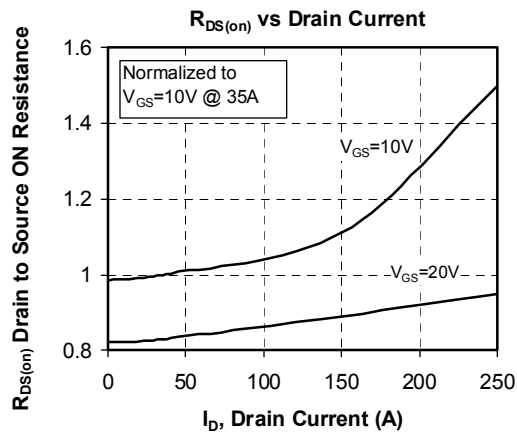
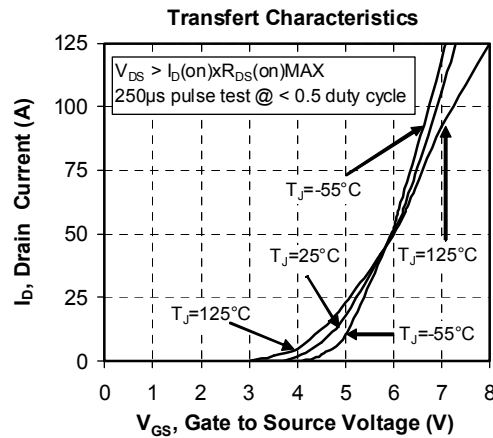
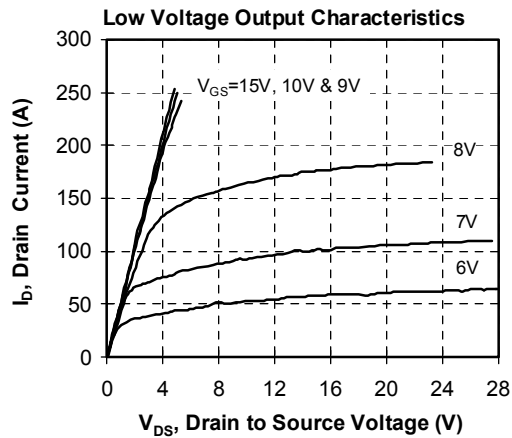
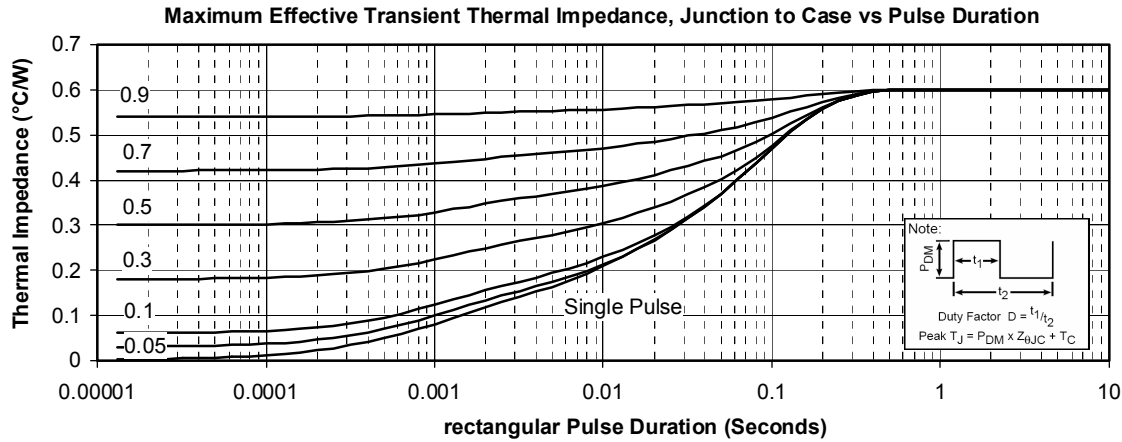
T: Thermistor temperature  
 R<sub>T</sub>: Thermistor value at T

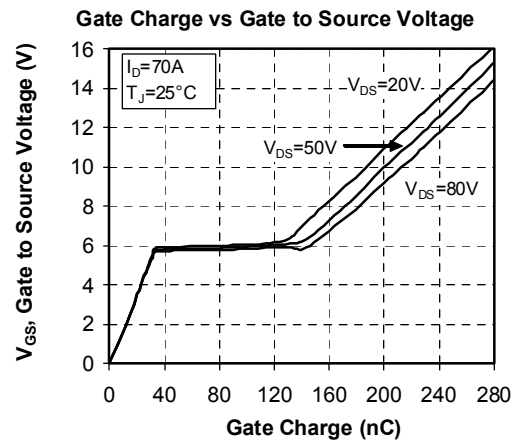
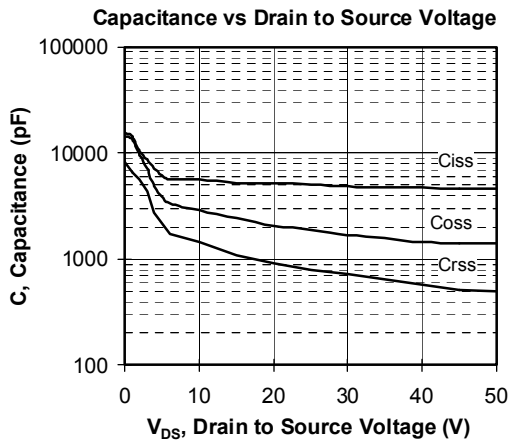
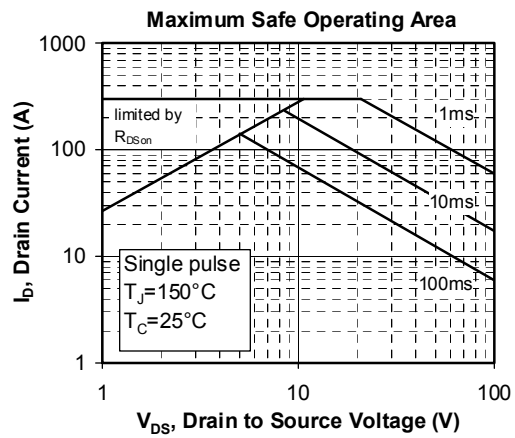
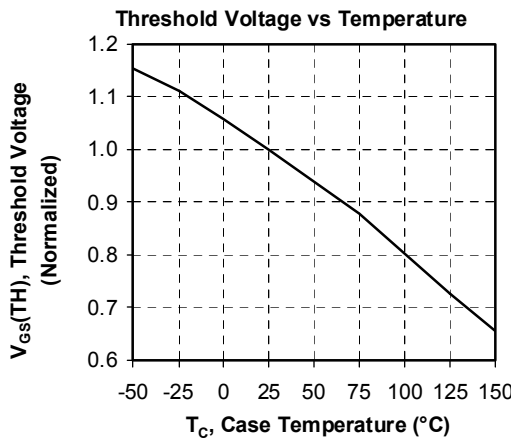
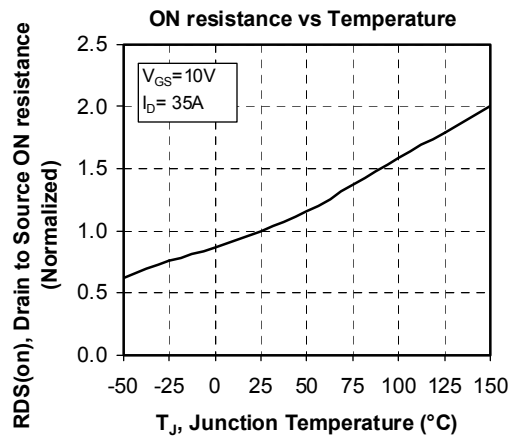
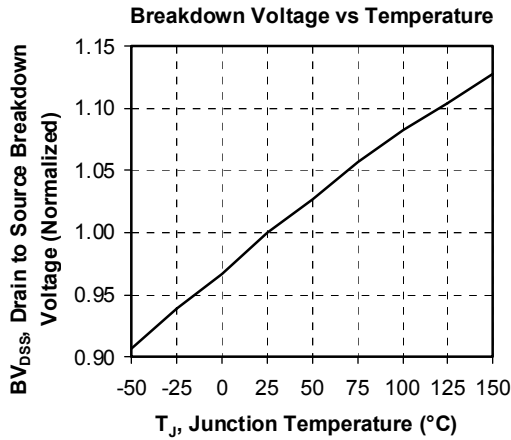
## SP3 Package outline (dimensions in mm)



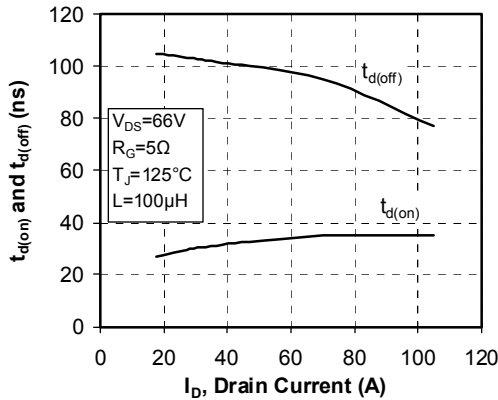
See application note 1901 - Mounting Instructions for SP3 Power Modules on [www.microsemi.com](http://www.microsemi.com)

## Typical Performance Curve

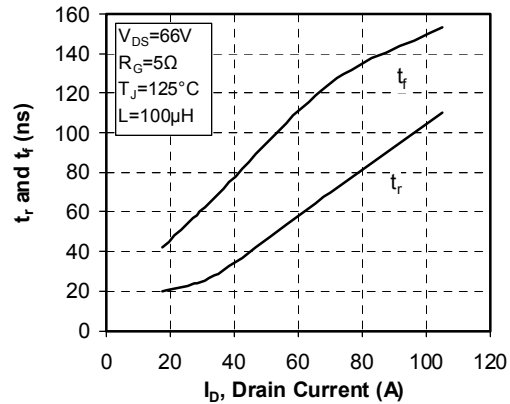




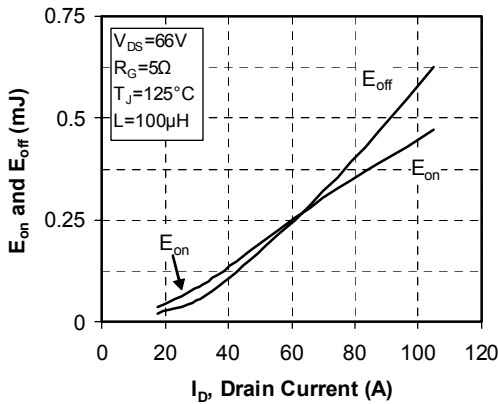
**Delay Times vs Current**



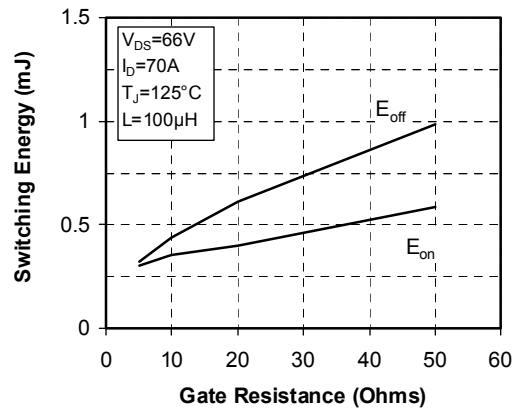
**Rise and Fall times vs Current**



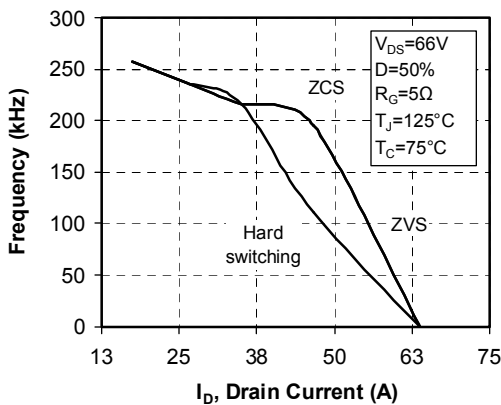
**Switching Energy vs Current**



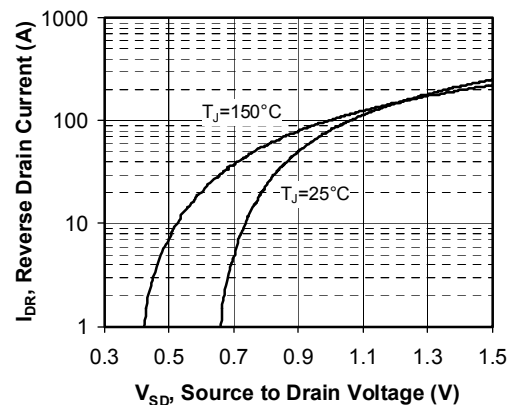
**Switching Energy vs Gate Resistance**



**Operating Frequency vs Drain Current**



**Source to Drain Diode Forward Voltage**



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